

Attorney Docket 033773 M 013

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:

Takahiro SAITO

US Serial No.: 09/752,563

Filed: January 3, 2001

For: METHOD OF CUTTING CSP SUBSTRATES

RECEIVED
DEC 2.7 2002
TECHNOLOGY CENTER R3700

Group Art Unit: 3724

Examiner: C. Goodman

PATENT

AMENDMENT

Commissioner for Patents Washington, DC 20231

Sir:

A response to the Office Action dated September 26, 2002 (Paper No. 3) is due by December 26, 2002. Therefore, please accept this Amendment as timely filed and fully responsive.

In response to Paper No. 3, kindly amend the above-identified patent application as follows:

IN THE DRAWINGS:

Pursuant to *M.P.E.P.* § 608.02(r), Applicant files with this Amendment, a Letter that describes a proposed change to original Fig. 1 in this application. Applicant respectfully requests the Examiner's and the Office Draftsperson's approval of this proposed change.